)5-20-2002	Case 5027 CPI/COPPER/PJS
FORM PTO-1595		U.S. Department of Commerce Putent And Trademark Office
To the Honorable Commissioner of Patents an	102094827	document or copy thereof.
1. Name of conveying party (les):		ss of receiving party(ies):
Ling Chen MAY 1 3 2002 Execution Date February 27, 2002	Name: Applie	ed Materials, Inc,
Wei Cao February 26, 2002		P.O. Box 450-A
Additional name(s) Additional party(ies) attached? _ Ye	es X No	
3. Nature of conveyance: X Assignment Merger	Street Address:_	
	City Sauta Cla	Shake OA 7:10 05053
Security Agreement Change of Name	City: Santa Cla	State: CA Zip: 95052
Other	Additional name(s)	& address(es) attached? Yes X_ No
4. Application number(s) or registration number(s):		
If this document is being filed together with a new applic of Filing)	cation, the execution date of the app	lication is:(Date
A. Patent Application No.(s) 10/052,049 fi	led 01/16/2002	
B. Patent No.(s)		
Additional numbers attached? Yes X No		
Name and address of party to whom correspondence con document should be mailed:	cerning 6. Total number of	applications and patents involved: 1
Name: Patent Counsel	7. Total fee (37 C.I	F.R. 3.41)
Internal Address: APPLIED MATERIALS, INC.	Enclosed	
	X Authorized to 50-1074	o be charged to deposit account
Street Address: P.O. Box 450-A		
	8. Deposit account	number:
City: Santa Clara State: CA Zip	: 95052 (Attach duplicate c	opy of this form if paying by deposit account)
D	O NOT USE THIS SPACE)
9. Statement and signature. To the best of my knowledge and belief, the foregoing in document.	formation is true and correct and b	
ROBERT W. MULCAHY Reg. No. 25,436 Name of Person Signing	Signature	Date 5 /03/12
1	0. Total number of pages including	g cover sheet, attachments and document: 5

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

05/17/2002 TDIAZ1 01 FC:581

00000061 501074

10052049

Washington, D.C. 20231

PATENT REEL: 012892 FRAME: 0918

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Ling Chen 784 Dartshire Way Sunnyvale, California 94087	2)	Wei Cao 1223 Elkwood Drive Milpitas, California 95035
L	Canny vaic, Camorria 04007		Milpitas, California 30000

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"METHOD FOR GROWING THIN FILMS BY CATALYTIC ENHANCEMENT"

for which application for Letters Patent in the United States was filed on 01/16/2002, Serial No. 10/052,049, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use

1 of 2

proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	Feb 27, 2002	Ling Chen	Z
2)	, 2002	Wei Cao	

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Ling Chen	2)	Wei Cao
	784 Dartshire Way		1223 Elkwood Drive
	Sunnyvale, California 94087		Milpitas, California 95035

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"METHOD FOR GROWING THIN FILMS BY CATALYTIC ENHANCEMENT"

for which application for Letters Patent in the United States was filed on 01/16/2002, Serial No. 10/052,049, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use

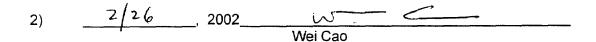
1 of 2

proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	 2002
	Ling Chen



RECORDED: 05/13/2002